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MCOT42005A1V-EYM 4 x 20			Euro/Jap/Cyrillic	OLED Module			
			Specification				
Versio	n: 4		Date: 10/10/2017				
Revision							
1	29/07/2	2014	First Issue.				
2 08/12/2015			Modify Life Time.				
3	01/06/2	2016	Modify Static Electricity Test.				
4	12/09/2	.017	Modify Reliability Test Condition.				

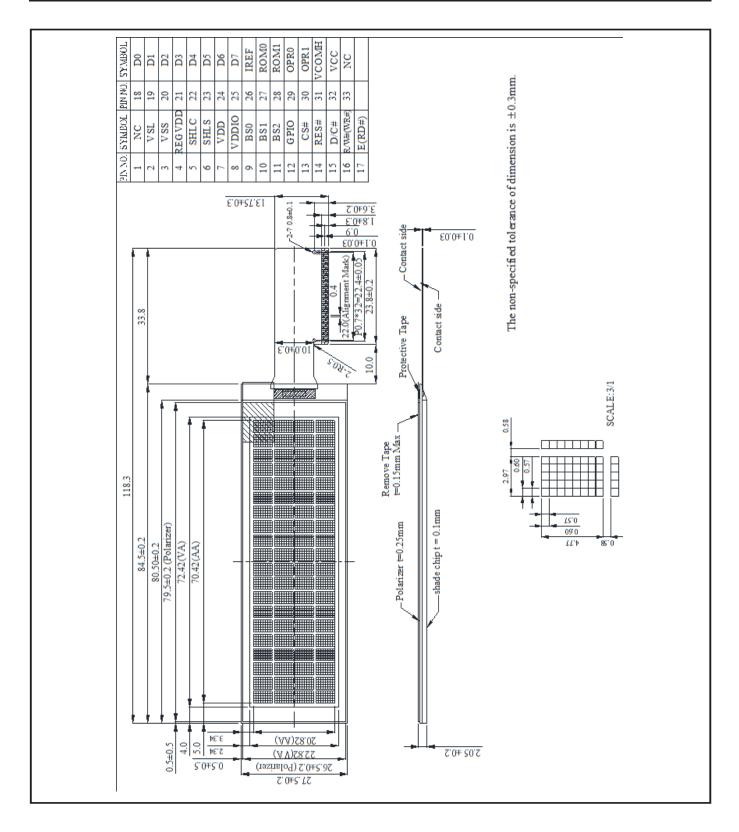
Displa			
Character Count	4 x 20		
Appearance	Yellow on Black		
Logic Voltage	5V		7)
Interface	Parallel / SPI / I2C		POHS
Font Set	English / Japanese / Cyrillic		ROHS ompliant
Character Height	4.77		Omphant
Module Size	84.50 x 27.50 x 2.05 mm		
Operating Temperature	-40°C ~ +70°C	Box Quantity	Weight / Display
Construction	TAB		

^{* -} For full design functionality, please use this specification in conjunction with the SSD1311 specification.(Provided Separately)

Display Accessories						
Part Number	Description					
MPBV4-Iss2	Direct solder-to-2mm pitch DIL pinout interface board. Compatible with: 0.7, 0.8, 0.845 and 1mm pitch pads.					
MCIB-13 V2	Direct solder OLED character interface board. Used in conjunction with MCIB-12 and UC32.					

Optional Variants						
Appearance	Voltage					
Green on Black White on Black						
Interface						

Mechanical Specifications										
Module Size	84.50 x 27.50 x 2.05 (Without Backlight) W x H x D mm									
Active Area	70.42 x 20.82	70.42 x 20.82 W x H mm Hole-to-Hole			W x H mm					
Character Size	2.97 x 4.77	W x H mm	Character Pitch	3.55 x 5.35	W x H mm					
Dot Size	0.57 x 0.57	W x H mm	Dot Pitch	0.60 x 0.60	W x H mm					



MCOT42005A1V-EYM	4 x 20	Euro/Jap/Cyrillic	OLED Module						
	Specification								
Version: 4		Date: 10/10/2017							
Revision									

Block Diagram



Display Position	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
DD RAM Address	00	01	02	03	04	05	06	07	08	09	OΑ	0в	0C	0D	OE	OF	10	11	12	13
DD RAM Address	20	21	22	23	24	25	26	27	28	29	2A	2в	2C	2D	2E	2 F	30	31	32	33
DD RAM Address	40	41	42	43	44	45	46	47	48	49	4 A	4B	4C	4D	4E	4F	50	51	52	53
DD RAM Address	60	61	62	63	64	65	66	67	68	69	6A	6B	6C	6D	6E	6F	70	71	72	73

MCOT42005A1V-EYM	4 x 20	Euro/Jap/Cyrillic	OLED Module						
	Specification								
Version: 4		Date: 10/10/2017							
Revision									

	Pin Layout											
Pin	Symbol	Description										
1	NC	lo connection										
2	VSL	his is segment voltage (output low level) reference pin. /hen external VSL is not used, this pin should be left open. /hen external VSL is used, connect with resistor and diode to ground (details depend on application).										
3	VSS	Ground pin. It must be connected to external ground.										
4	REGVDD	Internal VDD regulator selection pin in 5V I/O application mode. When this pin is pulled HIGH, internal VDD regulator is enabled (5V I/O application). When this pin is pulled LOW, internal VDD regulator is disabled (Low voltage I/O application).										
5	SHLC	This pin is used to determine the Common output scanning direction. COM scan direction SHLC										
6	SHLS	This pin is used to change the mapping between the display data column address and the Segment driver. SEG scan direction SHLS SEG direction 1 SEG0 to SEG99 (Normal) 0 SEG99 to SEG0 (Reverse) (1) 0 s connected to VSS (2) 1 s connected to VDDIO										
7	VDD	Power Supply For Core Logic Operation. VDD can be supplied externally or regulated internally. In LV IO application (internal VDD is disabled), this is a power input pin. In 5V IO application (internal VDD is enabled), VDD is regulated internally from VDDIO. A capacitor should be connected between VDD and VSS under all circumstances.										
8	VDDIO	Low voltage power supply and power supply for interface logic level in both Low Voltage I/O and 5V I/O application. It should match with the MCU interface voltage level and must be connected to external source.										
9	BS0	MCU bus interface selection pins. Select appropriate logic setting as described in the following table.										
10	BS1	BS2, BS1 and BS0 are pin select. Bus Interface selection										
11	BS2	BS[2:0] Interface										
12	GPIO	GPIO pin. Details refer to OLED command DCh.										
13	CS#	Chip Select Input Connecting to the MCU. The chip is enabled for MCU communication only when CS# is pulled LOW (active LOW). In I2C mode, this pin must be connected to VSS.										
14	RES#	Reset Signal Input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin pull HIGH during normal operation.										

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	Specification								
Version: 4		Date: 10/10/2017							
Revision									

		Data/Command Control Pin Connecting to the MCU.									
15	D/C#	When the pin is pulled HIGH, the data at D[7:0] will be interpreted as data. When the pin is pulled LOW, the data at D[7:0] will be transferred to a command register. I I2C mode, this pin acts as SA0 for slave address selection. When serial interface is selected, this pin must be connected to VSS.									
16	R/W#(WR#)	Read / Write Control Input Pin Connecting to the MCU interface. When 6800 interface mode is selected, this pin will be used as Read/Write (R/W#) selection input. Read mode will be carried out when this pin is pulled HIGH and write mode when LOW. When 8080 interface mode is selected, this pin will be the Write (WR#) input. Data write operation is nitiated when this pin is pulled LOW and the chip is selected. When serial or I2C interface is selected, this pin must be connected to VSS.									
17	E(RD#)	MCU Interface Input. When 6800 interface mode is selected, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled HIGH and the chip is selected. When 8080 interface mode is selected, this pin receives the Read (RD#) signal. Read operation is initiated when this pin is pulled LOW and the chip is selected. When serial or I2C interface is selected, this pin must be connected to VSS.									
18-25	D0~D7	Bi-directional Data Bus Connecting to the MCU data bus. Jnused pins are recommended to tie LOW. When serial interface mode is selected, D0 will be the serial clock input: SCLK; D1 will be the serial data input: SID and D2 will be the serial data output: SOD. When I2C mode is selected, D2, D1 should be tied together and serve as SDAout, SDAin in application and D0 is the serial clock input, SCL.									
26		Segment Output Current Reference pin. IREF is supplied externally. A resistor should be connected between this pin and VSS to maintain current of around 15uA.									
27		These pins are used to select Character ROM; select appropriate logic setting as described in the following table. ROM1 and ROM0 are pin select as shown in below table: Character ROM selection ROM1 ROM0 ROM 0 0 A 0 1 B									
28	ROM1	1									
29	OPR0	This pin is used to select the character number of character generator. Character RAM selection OPRI OPRO CGROM CGRAM I I 256 0 0 1 248 8									
30	OFIXE	1									
31	VCOMH	COM signal deselected voltage level. A capacitor should be connected between this pin and VSS. No external power supply can connect to this pin.									
32	VCC	Power Supply for Panel Driving Voltage. This is also the most positive power voltage supply pin. It is supplied by external high voltage source.									
33	NC	No connection.									

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Specification							
Version: 4		Date: 10/10/2017					
	Revision						

Font Map

Upper 4bit	LLLL	LLLH	LLHL	HIND	1 11 1	ו ווו וו	LULII	LHHH	шпп	الا الا	шші	шы г	HHHL	
Lower 4bit	LLLL	LLLN				LULU			ПЦЦ	піпі	HHLL	ппцп		
LLLL	CG RAM (1)													
LLLH	(2)													
LLHL	(3)													
LLHH	(4)													
LHLL	(5)													
LHLH	(6)													
LHHL	(7)													
LHHH	(8)													
HLLL	(1)													
HLLH	(2)													
HLHL	(3)													
HLHH	(4)													
HHLL	(5)													
HHLH	(6)													
HHHL	(7)													
нннн	(8)													

MCOT42005A1V-EYM	4 x 20	Euro/Jap/Cyrillic	OLED Module				
		Specification					
Version: 4		Date: 10/10/2017					
		Revision					

Upper 4bit Lower	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	НЬНН	HHLL	HHLH	HHHL	нннн
4bit LLLL	CG RAM (1)															
LLLH	(2)															
LLHL	(3)															
LLHH	(4)															
LHLL	(5)															
LHLH	(6)															
LHHL	(7)															
LHHH	(8)															
HLLL	(1)															
HLLH	(2)															
HLHL	(3)															
HLHH	(4)															
HHLL	(5)															
HHLH	(6)															
HHHL	(7)															
нннн	(8)															

MCOT42005A1V-EYM	4 x 20	Euro/Jap/Cyrillic	OLED Module			
		Specification				
Version: 4 Date: 10/10/2017						
		Revision				

Upper 4bit Lower 4bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	ННГН	HHHL	
LLLL	CG RAM (1)															
LLLH	(2)															
LLHL	(3)															
LLHH	(4)															
LHLL	(5)															
LHLH	(6)															
LHHL	(7)															
LHHH	(8)															
HLLL	(1)															
HLLH	(2)															
HLHL	(3)															
нцнн	(4)															
HHLL	(5)															
HHLH	(6)															
HHHL	(7)															
нннн	(8)															

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		Specification					
Version: 4		Date: 10/10/2017					
		Revision					

Absolute Maximum Ratings										
Item Symbol Condition Min Typ Max Unit										
Supply Voltage for Logic	VDDIO		-0.3		6.00	V				
Input Voltage	VI		-0.3		VDD	°C				
Operating Temperature	TOP		-40		70	°C				
Storage Temperature	TST		-40		85	°C				

Electronic Characteristics										
Item	Symbol	Condition	Minimum	Typical	Maximum	Unit				
Input High Voltage	VIH		0.80xVDD			V				
Input Low Voltage	VIL				0.20xVDD	V				
Output High Voltage	VOH	IOH=0.5mA	0.90xVDD			V				
Output Low Voltage	VOL	IOL=0.5mA			0.10xVDD	V				
Supply Voltage for Logic	VDD/VSS		4.80	5.00	5.30	V				
Supply Voltage for Display	VCC		9.00	10.00	11.00	V				
50% Checkboard Operating Current.	ICC	VDD=5V	17	19	21	mA				
CIEx(Yellow)		(CIE1931)	0.45	0.47	0.49					
CIEy(Yellow)		(CIE1931)	0.48	0.50	0.52					

OLED Characteristics										
Item Symbol Condition Minimum Typical Maximum Unit										
Viowing Angle	(V)θ		160			Deg				
Viewing Angle	(Η)φ		160			Deg				
Contrast Ratio	CR	Dark	2000:1							
Dooponee Time	T Rise			10		μs				
Response Time	T Fall			10		μs				
Display with 5	50% Checkboard B	rightness	120	130		cd/m ²				

OLED Life Time									
Item Conditions Typical Remark									
Operating Life Time	Ta=25°C. Initial checkboard brightness. 50%.	50,000 Hours							

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